

### 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Low threshold voltage
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

### 3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-12	V
V <sub>GS</sub>	gate-source voltage			-8	-	8	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-	-30.6	А
Static chara	acteristics						
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 25 °C		-	3.2	3.7	mΩ
		V <sub>GS</sub> = -2.5 V; I <sub>D</sub> = -15.9 A; T <sub>j</sub> = 25 °C		-	4.1	5.1	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



# 5. Pinning information

Table 2	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source	1 2 3 4					
2	S	source	ريت ف-ف-ف-ف-					
3	S	source						
4	G	gate	Ľ Ÿ					
5	D	drain						
6	D	drain	— Церей	S 017aaa257				
7	D	drain						
8	D	drain	MLPAK33 (SOT8002-1)					

# 6. Ordering information

Table 3. Ordering information						
Type number Package						
	Name	Description	Version			
PXP3R7-12QU		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1			

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
PXP3R7-12QU	9AR

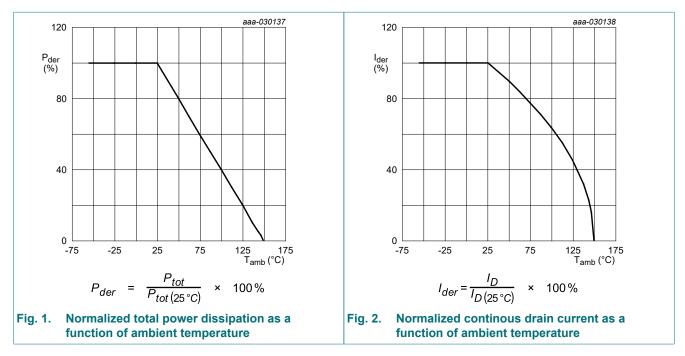
### 8. Limiting values

#### Table 5. Limiting values

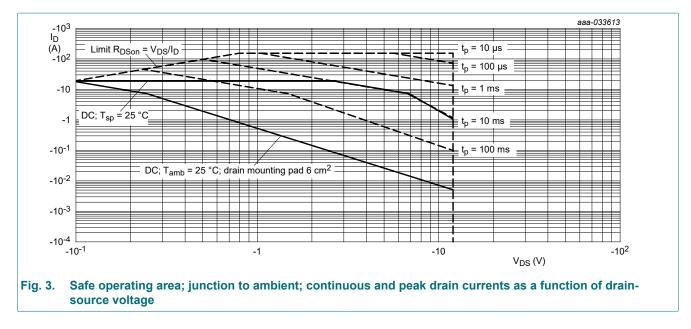
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-12	V
V <sub>GS</sub>	gate-source voltage	_		-8	8	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-30.6	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-18.7	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	-11.8	А
		V <sub>GS</sub> = -4.5 V; T <sub>sp</sub> = 25 °C		-	-98.6	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-154	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T <sub>amb</sub> = 25 °C	[1]	-	1.8	W
		T <sub>sp</sub> = 25 °C		-	50	W
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-drai	n diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.7	А
		1				

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



### 12 V, P-channel Trench MOSFET

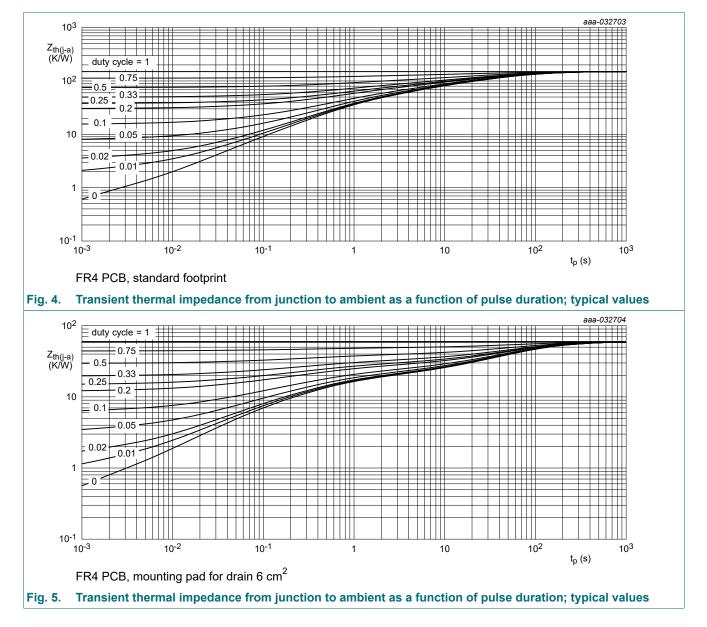


## 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient		[1]	-	145	185	K/W
			[2]	-	55	70	K/W
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	1.5	2.5	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

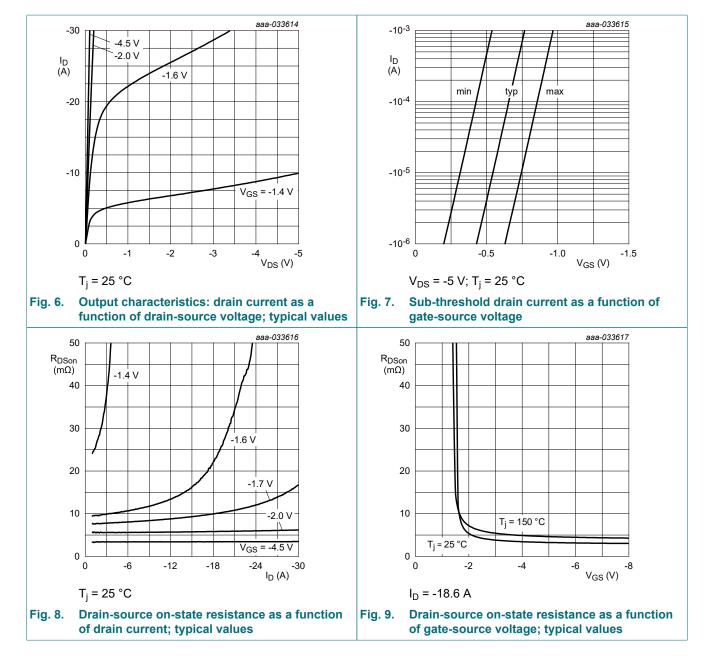


# **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = -250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-12	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.47	-0.7	-0.9	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = -12 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-1	μA
I <sub>GSS</sub> gate le	gate leakage current	V <sub>GS</sub> = -8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-100	nA
		V <sub>GS</sub> = 8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 25 °C	-	3.2	3.7	mΩ
	resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 150 °C	-	4.4	5.1	mΩ
		V <sub>GS</sub> = -2.5 V; I <sub>D</sub> = -15.9 A; T <sub>j</sub> = 25 °C	-	4.1	5.1	mΩ
		V <sub>GS</sub> = -1.8 V; I <sub>D</sub> = -4 A; T <sub>j</sub> = 25 °C	-	6.2	8.5	mΩ
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 25 °C	-	65	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz	-	4.5	-	Ω
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub>	total gate charge	V <sub>DS</sub> = -6 V; I <sub>D</sub> = -15.9 A; V <sub>GS</sub> = -4.5 V;	-	75	110	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	9.8	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge	-	-	4.9	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	4.9	-	nC
Q <sub>GD</sub>	gate-drain charge	1	-	20.5	-	nC
V <sub>GSpl</sub>	gate-source plateau voltage	V <sub>DS</sub> = -6 V; I <sub>D</sub> = -15.9 A; T <sub>j</sub> = 25 °C	-	-1.5	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -6 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	6500	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	1500	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	1300	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -6 V; I <sub>D</sub> = -15.9 A; V <sub>GS</sub> = -4.5 V;	-	8	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	33	-	ns
t <sub>d(off)</sub>	turn-off delay time	1	-	217	-	ns
t <sub>f</sub>	fall time	1 – – – – – –	-	177	-	ns
Source-drai	n diode	· ·	1			
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.7 A; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	-0.7	-1.2	V

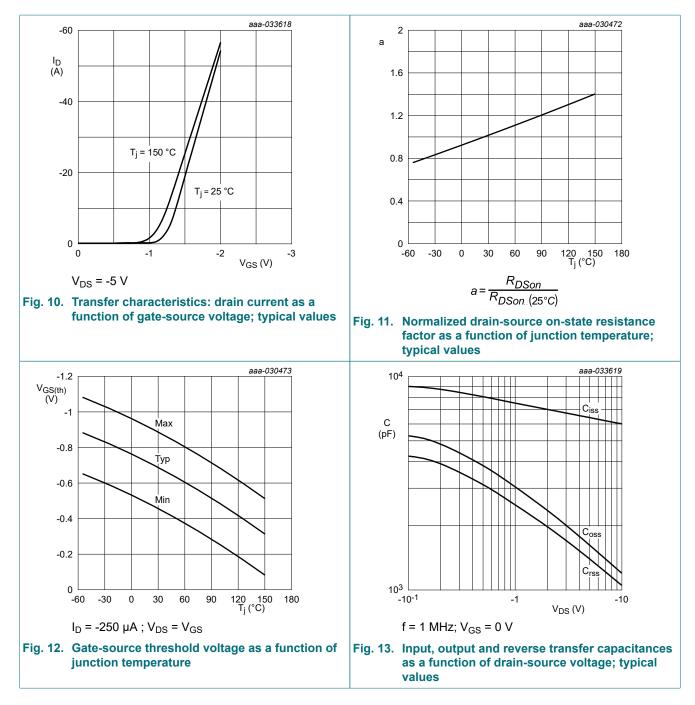
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### 12 V, P-channel Trench MOSFET

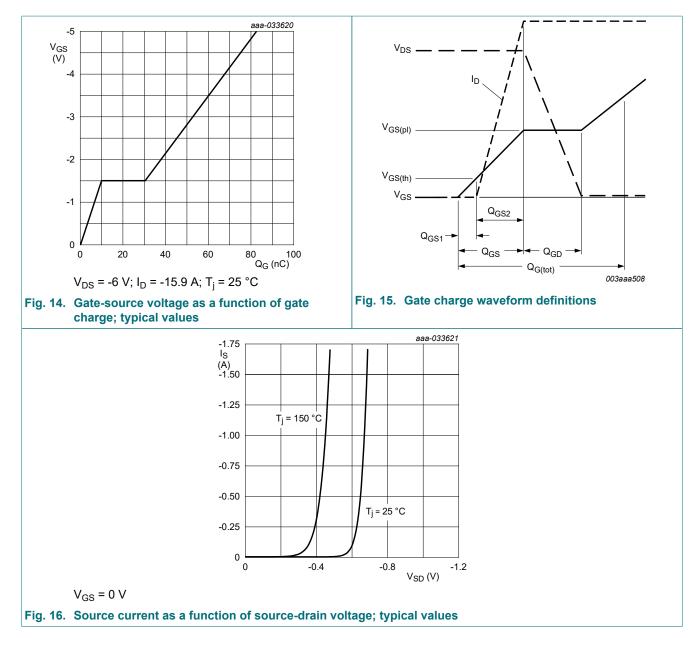


**Product data sheet** 

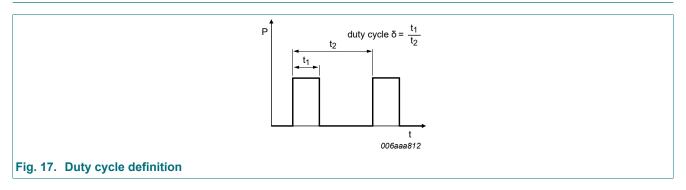
### 12 V, P-channel Trench MOSFET



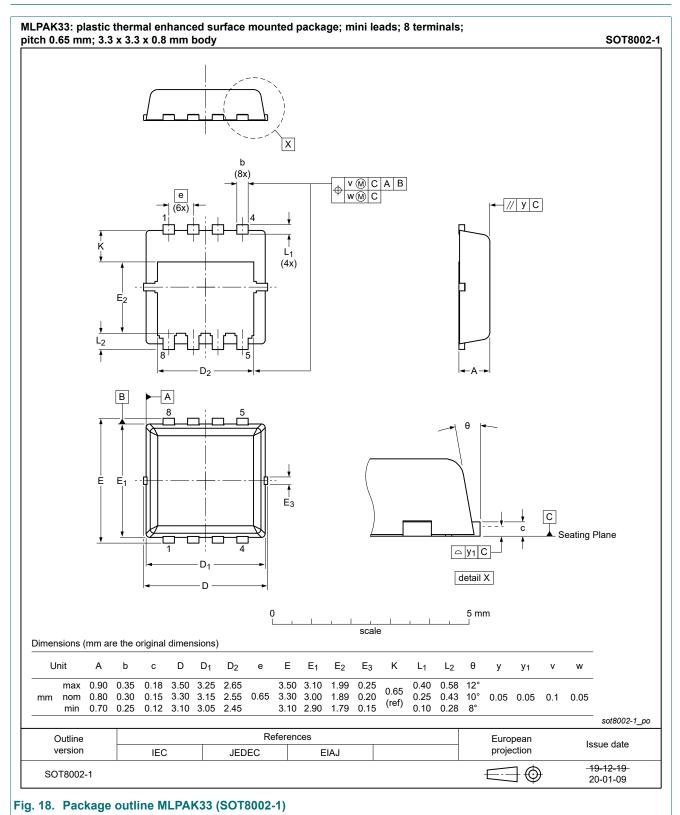
### 12 V, P-channel Trench MOSFET



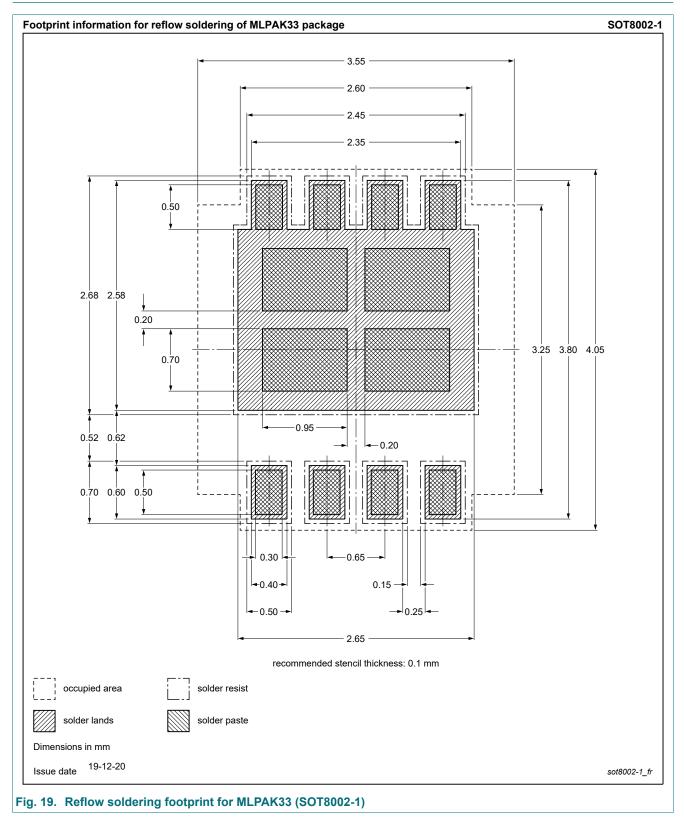
### **11. Test information**



### 12. Package outline



# 13. Soldering



# 14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PXP3R7-12QU v.1	20210906	Product data sheet	-	-		

### 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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